

**DECLARATION AND POWER OF ATTORNEY
FOR UNITED STATES PATENT APPLICATION**

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name,

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a nonprovisional patent application is being filed for the invention entitled

**DIRECT
SYNTHESIS OF OXIDE NANOSTRUCTURES OF LOW-MELTING METALS**

described and claimed in the specification which:

(check one) X is attached hereto;

_____ was filed on _____ as Application;
Serial No. _____ and was amended on _____
(if applicable)

I hereby state that I have reviewed and understand the contents of the above identified specification, including the claims, as amended by any amendment referred to above.

I acknowledge the duty to disclose information which is material to the patentability of this application in accordance with Title 37, Code of Federal Regulations, §1.56.

I hereby claim foreign priority benefits under Title 35, United States Code, §119(a)-(d) of any foreign application(s) for

patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application on which priority is claimed:

Prior Foreign Application(s)	Priority Claimed
<u>NONE</u> (Number) (Country) (Day/Month/Year Filed)	<u>Yes</u> <u>No</u>
 (Number) (Country) (Day/Month/Year Filed)	 <u>Yes</u> <u>No</u>

I hereby claim the benefit under Title 35, United States Code §119(e) of any United States provisional application(s) listed below:

<u>60/411,116</u> (Application Number)	<u>September 16, 2002</u> (Filing Date)
 (Application Number)	 (Filing Date)

I hereby claim the benefit under Title 35, United States Code, §120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code, §112, I acknowledge the duty to disclose material information as defined in Title 37, Code of Federal Regulations, §1.56 which occurred between the filing date of the prior application and the national or PCT international

filing date of this application:

<u>NONE</u>		
(Appln. Serial No.)	(Filing Date)	(Status)
		(patented, pending, abandoned)

(Appln. Serial No.)	(Filing Date)	(Status)
		(patented, pending, abandoned)

I hereby appoint David W. Carrithers, Reg. No. 35,475 as my attorney, to prosecute this application and to transact all business in the U.S. Patent and Trademark Office connected therewith, and I request that all communications concerning this application be addressed to:

**David W. Carrithers
CARRITHERS LAW OFFICE
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Telephone (502) 452-1233**

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 or the United States Code and that such willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

Full name of first inventor: Shashank Sharma

Inventor's signature: _____ Date: _____

Residence: 2201 James Guthrie Court, Apt #3, Louisville, KY 40217

Citizenship: India

Post Office Address: Same

Full name of second inventor: Mahendra Kumar Sunkara

Inventor's signature: _____ Date: _____

Residence: 17110 Polo Fields Lane, Louisville, KY 40245

Citizenship: India

Post Office Address: Same